

Solid Tantalum Chip Capacitors MICROTAN® High Reliability, Low DC Leakage, Leadframeless Molded



PERFORMANCE CHARACTERISTICS

www.vishay.com/doc?40170

Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required) Capacitance Range: 0.33 µF to 47 µF

Capacitance Tolerance: ± 10 % and ± 20 % standard

Voltage Range: 2 V_{DC} to 40 V_{DC}

FEATURES

· High reliability solid surface mount tantalum capacitors



- · Low DC leakage for extended battery life
- Small sizes for space constrained applications
- · L-shaped face-down terminations for superior board
- mounting Suitable for medical implantable applications with additional screening
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

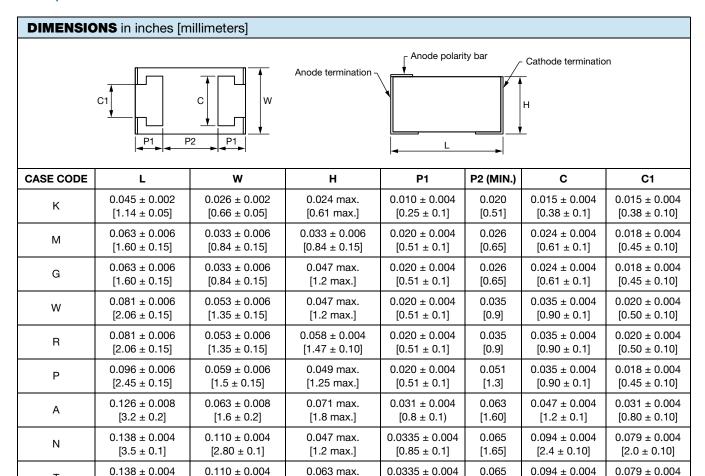
TM8	R	106	M	016	E	В	Α
MODEL	CASE	CAPACITANCE	CAPACITANCE	DC VOLTAGE	TERMINATION /	RELIABILITY	SURGE
	CODE		TOLERANCE I	RATING AT +85 °C	PACKAGING I	LEVEL I	CURRENT I
	See	This is	K = ± 10 %	This is expressed	Sn / Pb solder	B = 0.1 %	A = 10 cycles
	Ratings	expressed in	$M = \pm 20 \%$	in volts. To complete	E = 7" (178 mm) reels	weibull FRL	at 25 °C
	and	picofarads.		the three-digit block,	L = 7" (178 mm) reels,	S = hi-rel std.	B = 10 cycles
	Case	The first two		zeros precede the	½ reel	(40 h burn-in)	at -55 °C /
	Codes	digits are the		voltage rating.	R = 7" (178 mm)	Z = non-	+85 °C
	table	significant		A decimal point is	300 pcs. qty.	established	Z = none
		figures. The		indicated by an "R"		reliability	L
		third is the		(6R3 = 6.3 V).	<u>100 % tin</u>		
		number of			C = 7" (178 mm) reels		
		zeros to			H = 7" (178 mm) reels,		
		follow.			½ reel		
		<u> </u>			U = 7" (178 mm)		
					300 pcs. qty.		
					Gold		
					A = 7" (178 mm) reels		
					G = 7" (178 mm) reels,		
					½ reel		
					P = 7" (178 mm)		
					300 pcs. qty.		

Τ

 $[3.5 \pm 0.1]$

 $[2.80 \pm 0.10]$

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RATINGS AND CASE CODES									
μF	2 V	4 V	6.3 V	10 V	16 V	20 V	25 V	40 V	
0.33						K			
0.68						М			
1.0		К	K	М	М	M/W	R	Р	
2.2				М	М				
3.3			М	M/G	R	R			
4.7			М	М			Р		
6.8				R	R				
7.5				W		N			
10	K	М	М	R	R/A	А			
15		М	M/R	R					
22				А					
33		Р	Р						
47		Р	P/T	Т					

[1.57 max.]

 $[0.85 \pm 0.1]$

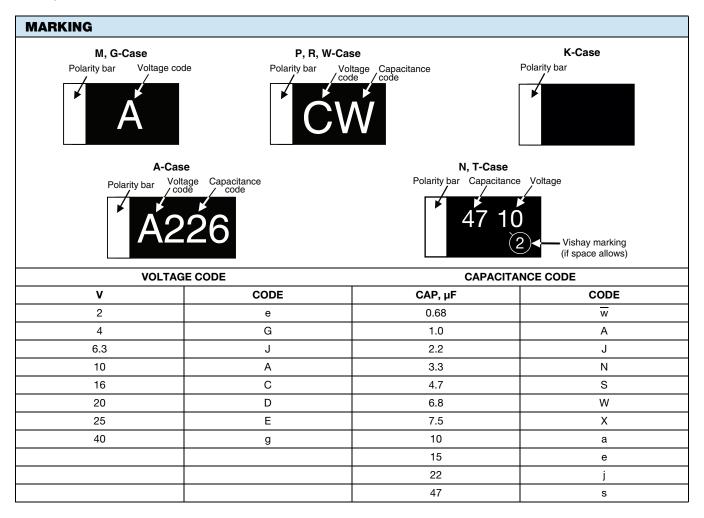
[1.65]

 $[2.4 \pm 0.10]$

 $[2.0 \pm 0.10]$



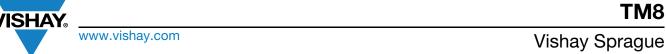




STANDARD R	ATINGS					
CAPACITANCE (µF)	CASE CODE	PART NUMBER	MAX. DCL AT +25 °C (μΑ)	MAX. DF AT +25 °C (%)	MAX. ESR AT +25 °C 100 kHz STD. (Ω)	AVAILABLE RELIABILITY LEVELS
		2 V _{DC} AT +8	5 °C; 1.4 V _{DC} AT +	125 °C		
10	K	TM8K106M002(2)(4)(6)	0.50	20	20.0	Z
		4 V _{DC} AT +8	5 °C; 2.7 V _{DC} AT +	125 °C		
1.0	K	TM8K105(1)004(2)(3)(6)	0.20	8	20.0	Z, S, B
10	М	TM8M106(1)004(2)(3)(5)	0.20	8	5.0	Z, S, B
15	М	TM8M156(1)004(2)(3)(5)	0.30	8	5.0	Z, S, B
33	Р	TM8P336(1)004(2)(3)(5)	0.66	30	6.0	Z, S, B
47	Р	TM8P476(1)004(2)(3)(5)	0.94	22	3.0	Z, S, B

Note

- Part number definitions:
 - (1) Capacitance tolerance: K, M
 - (2) Termination and packaging: E, L, R, C, H, U, A, G, P
 - (3) Reliability level: Z, S, B (4) Reliability level: Z only
 - (5) Surge current: Z, A, B
 - (6) Surge current: Z only

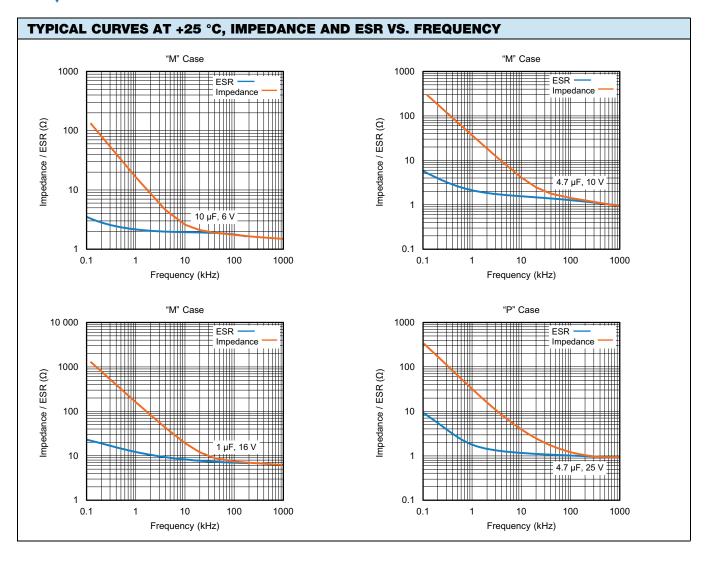


CAPACITANCE (μF)	CASE CODE	PART NUMBER	MAX. DCL AT +25 °C (μA)	MAX. DF AT +25 °C (%)	MAX. ESR AT +25 °C 100 kHz STD.	AVAILABLE RELIABILITY LEVELS
		6.3 V _{DC} AT -	+85 °C; 4 V _{DC} AT +	·125 °C	(Ω)	
1.0	K	TM8K105(1)6R3(2)(3)(6)	0.20	8	20.0	Z, S, B
3.3	М	TM8M335(1)6R3(2)(3)(5)	0.20	8	6.0	Z, S, B
4.7	M	TM8M475(1)6R3(2)(3)(5)	0.20	8	6.0	Z, S, B
10	M	TM8M106(1)6R3(2)(3)(5)	0.32	8	5.0	Z, S, B Z, S, B
15	M	TM8M156(1)6R3(2)(3)(5)	0.47	8	5.0	Z, S, B Z, S, B
15	R		0.47	8	5.0	Z, S, B Z, S, B
33	n P	TM8R156(1)6R3(2)(3)(5) TM8P336(1)6R3(2)(3)(5)	1.00	30	6.0	
	P	() () () ()				Z, S, B
47		TM8P476(1)6R3(2)(3)(5)	1.50	22	3.0	Z, S, B
47	Т	TM8T476(1)6R3(2)(3)(5)	1.50	8	0.5	Z, S, B
			+85 °C; 7 V _{DC} AT +			
1.0	М	TM8M105(1)010(2)(3)(5)	0.20	6	12.0	Z, S, B
2.2	М	TM8M225(1)010(2)(3)(5)	0.20	10	10.0	Z, S, B
3.3	М	TM8M335(1)010(2)(3)(5)	0.20	8	6.0	Z, S, B
4.7	М	TM8M475(1)010(2)(3)(5)	0.24	8	6.0	Z, S, B
3.3	G	TM8G335(1)010(2)(3)(5)	0.20	8	6.0	Z, S, B
7.5	W	TM8W755(1)010(2)(3)(5)	0.38	8	8.0	Z, S, B
6.8	R	TM8R685(1)010(2)(3)(5)	0.34	6	6.0	Z, S, B
10	R	TM8R106(1)010(2)(3)(5)	0.50	8	6.0	Z, S, B
15	R	TM8R156(1)010(2)(3)(5)	0.75	8	5.0	Z, S, B
22	Α	TM8A226(1)010(2)(3)(5)	1.10	8	1.5	Z, S, B
47	Т	TM8T476(1)010(2)(3)(5)	2.35	8	1.0	Z, S, B
			85 °C; 10 V _{DC} AT +			, -,
1.0	М	TM8M105(1)016(2)(3)(5)	0.20	6	12.0	Z, S, B
2.2	М	TM8M225(1)016(2)(3)(5)	0.20	10	10.0	Z, S, B
3.3	R	TM8R335(1)016(2)(3)(5)	0.26	8	8.0	Z, S, B
6.8	R	TM8R685(1)016(2)(3)(5)	0.54	6	6.0	Z, S, B
10	R	TM8R106(1)016(2)(3)(5)	0.80	8	6.0	Z, S, B
10	Α	TM8A106(1)016(2)(3)(5)	0.80	8	3.0	Z, S, B
10			85 °C; 13 V _{DC} AT +		0.0	2, 0, 5
0.33	K	TM8K334(1)020(2)(3)(6)	0.20	6	100.0	Z, S, B
0.68	M	TM8M684(1)020(2)(3)(5)	0.20	6	20.0	Z, S, B
1.0	M	TM8M105(1)020(2)(3)(5)	0.20	6	12.0	Z, S, B
1.0	W		0.20	8	8.0	Z, S, B
3.3	vv R	TM8W105(1)020(2)(3)(5) TM8R335(1)020(2)(3)(5)	0.33	8	8.0	Z, S, B Z, S, B
5.5 7.5	N	TM8N755(1)020(2)(3)(5)	0.75	8	6.0	Z, S, B Z, S, B
		, , , , , , ,				
10	A	TM8A106(1)020(2)(3)(5)	1.00 85 °C; 17 V_{DC} AT +	8 125 °C	3.0	Z, S, B
1.0	P		0.20		10.0	700
1.0	R	TM8R105(1)025(2)(3)(5)		6	10.0	Z, S, B
4.7	Р	TM8P475(1)025(2)(3)(5)	0.59	6	6.0	Z, S, B
1.0			85 °C; 27 V _{DC} AT +		40.0	7.0.5
1.0	Р	TM8P105(1)040(2)(3)(5)	0.20	8	10.0	Z, S, B

Note

- Part number definitions:
 - (1) Capacitance tolerance: K, M
 - (2) Termination and packaging: E, L, R, C, H, U, A, G, P
 - (3) Reliability level: Z, S, B (4) Reliability level: Z only (5) Surge current: Z, A, B
 - (6) Surge current: Z only





STANDARD PACKAGING QUANTITY						
CASE CODE	QUANTITY (PCS/REEL)					
CASE CODE	7" REEL	½ REEL	PARTIAL REEL			
К	5000	2500	300			
М	4000	2000	300			
G	3000	1500	300			
W	2500	1250	300			
R	2500	1250	300			
Р	3000	1500	300			
A	2000	1000	300			
N	2500	1250	300			
Т	2500	1250	300			



POWER DISSIPATION	
CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION AT +25 °C (W) IN FREE AIR
К	0.015
M	0.025
G	0.025
W	0.040
R	0.045
P	0.045
А	0.075
N	0.075
Т	0.084

PRODUCT INFORMATION					
Micro Guide					
Pad Dimensions	www.vishay.com/doc?40115				
Packaging Dimensions					
Moisture Sensitivity	www.vishay.com/doc?40135				
Typical Performance Characteristics	www.vishay.com/doc?40170				
SELECTOR GUIDES					
Solid Tantalum Selector Guide	www.vishay.com/doc?49053				
Solid Tantalum Chip Capacitors	www.vishay.com/doc?40091				
FAQ					
Frequently Asked Questions	www.vishay.com/doc?40110				

Guide for Leadframeless Molded Tantalum Capacitors

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum / tantalum oxide / manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance / volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance / volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS						
DIELECTRIC	e DIELECTRIC CONSTANT					
Air or Vacuum	1.0					
Paper	2.0 to 6.0					
Plastic	2.1 to 6.0					
Mineral Oil	2.2 to 2.3					
Silicone Oil	2.7 to 2.8					
Quartz	3.8 to 4.4					
Glass	4.8 to 8.0					
Porcelain	5.1 to 5.9					
Mica	5.4 to 8.7					
Aluminum Oxide	8.4					
Tantalum Pentoxide	26					
Ceramic	12 to 400K					

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = capacitance

e = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.

Revision: 10-Mar-2020 1 Document Number: 40115



SOLID ELECTROLYTE TANTALUM CAPACITORS

Solid electrolyte capacitors contain manganese dioxide, which is formed on the tantalum pentoxide dielectric layer by impregnating the pellet with a solution of manganous nitrate. The pellet is then heated in an oven, and the manganous nitrate is converted to manganese dioxide.

The pellet is next coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the pellet and the leadframe.

Molded chip tantalum capacitor encases the element in plastic resins, such as epoxy materials. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for consumer and commercial electronics with the added feature of low cost.

Surface mount designs of "Solid Tantalum" capacitors use lead frames or lead frameless designs as shown in the accompanying drawings.

TANTALUM CAPACITORS FOR ALL DESIGN CONSIDERATIONS

Solid electrolyte designs are the least expensive for a given rating and are used in many applications where their very small size for a given unit of capacitance is of importance. They will typically withstand up to about 10 % of the rated DC working voltage in a reverse direction. Also important are their good low temperature performance characteristics and freedom from corrosive electrolytes.

Vishay Sprague patented the original solid electrolyte capacitors and was the first to market them in 1956. Vishay Sprague has the broadest line of tantalum capacitors and has continued its position of leadership in this field. Data sheets covering the various types and styles of Vishay Sprague capacitors for consumer and entertainment electronics, industry, and military applications are available where detailed performance characteristics must be specified.

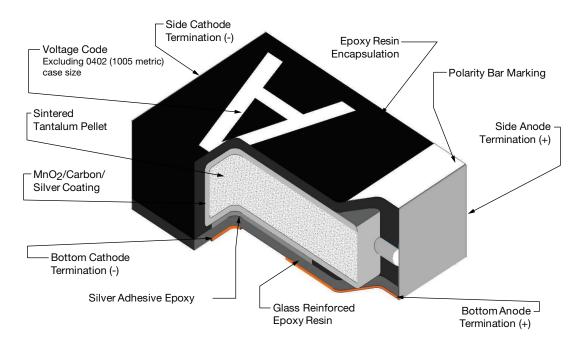


Fig. 1 - Leadframeless Molded Capacitors, All Types



SOLID TANTALUM CA	SOLID TANTALUM CAPACITORS - LEADFRAMELESS MOLDED									
SERIES	TL8	298D	298W	TR8						
PRODUCT IMAGE	9									
TYPE		Solid tantalum leadframeless molded chip capacitors								
	Small size including 0603 and 0402 foot print									
FEATURES	Ultra low profile	Industrial grade	Industrial grade, extended range	Low ESR						
TEMPERATURE RANGE	Operating Temperature: -55 °C to +125 °C (above 40 °C, voltage derating is required)	Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required)	Operating Temperature: -55 °C to +125 °C (above 40 °C, voltage derating is required)	Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required)						
CAPACITANCE RANGE	0.68 μF to 220 μF	0.33 μF to 220 μF	2.2 μF to 220 μF	1 μF to 220 μF						
VOLTAGE RANGE	4 V to 25 V	2.5 V to 50 V	4 V to 16 V	2.5 V to 25 V						
CAPACITANCE TOLERANCE	± 10 %									
DISSIPATION FACTOR	6 % to 80 %	6 % to 80 %	30 % to 80 %	6 % to 80 %						
CASE CODES	W9, A0, B0 K, M, R, P, Q, A, S, B		K, M, Q	M, R, P, Q, A, B						
TERMINATION	100 % tin	100 % tin 100 % tin or gold plated								

SOLID TANTALUM CA	SOLID TANTALUM CAPACITORS - LEADFRAMELESS MOLDED									
SERIES	TP8	TM8	DLA 11020	T42						
PRODUCT IMAGE	66 66									
TYPE		Solid tantalum leadframele	ss molded chip capacitors							
FEATURES	Small siz	Built in fuse, double-stacked								
FEATURES	High performance, automotive grade	High reliability	High reliability, DLA approved	High reliability, ultra-low ESR						
TEMPERATURE RANGE	-55	Operating T o °C to +125 °C (above 85 °C	emperature: C, voltage derating is requi	red)						
CAPACITANCE RANGE	1 μF to 100 μF	0.68 μF to 47 μF	1 μF to 47 μF	10 μF to 470 μF						
VOLTAGE RANGE	6.3 V to 40 V	2 V to 40 V	6.3 V to 40 V	16 V to 75 V						
CAPACITANCE TOLERANCE		± 20 %,	± 10 %							
DISSIPATION FACTOR	6 % to 30 %	6 % to 20 %	6 % to 8 %	6 % to 15 %						
CASE CODES	M, W, R, P, A, N, T, B	K, M, G, W, R, P, A, N, T	M, W, R, P, A, N, T	M2						
TERMINATION	100 % tin	Tin / lead solder plated, 100 % tin and gold plated	Tin / lead solder plated or gold plated	Tin / lead solder plated or 100 % tin						

available on plastic embossed tape per EIA-481.

Standard reel diameter is 7" [178 mm].



PLASTIC TAPE AND REEL PACKAGING in inches [millimeters] 0.157 ± 0.004 10 pitches cumulative $[4.0 \pm 0.10]$ tolerance on tape Tape thickness Deformation ± 0.008 [0.200] 0.059 + 0.004 - 0.0 between [1.5 + 0.10 - 0.0]Embossment 0.014 embossments 0.079 ± 0.002 0.069 ± 0.004 [0.35] $[2.0 \pm 0.05]$ (1.75 ± 0.10) max. Top cover ¥ 0.030 [0.75] tape min. (3) W B₄ (max.) Maximum component 0.030 [0.75] rotation Top cover min. (4) tape (Side or front sectional view) Center lines For tape feeder 0.004 [0.10] D₁ (min.) for components of cavity 0.079×0.047 [2.0 x 1.2] and larger $^{(5)}$ reference only max **USER DIRECTION** including draft. Maximum OF FEED Concentric around B₀ (5) cavity size (1) Cathode (-) O 0 0 DIRECTION OF FEED 3.937 [100.0] 20° maximum 0.039 [1.0] component rotation Typical component Tape and Reel Specifications: all case sizes are

Notes

(Top view)

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only
- A₀, B₀, K₀, are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀, K₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°

0.039 [1.0]

0.9843 [250.0]

Camber

(Top view)

Allowable camber to be 0.039/3.937 [1/100]

Non-cumulative over 9.843 [250.0]

- Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide 'R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum
- This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less

 This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier
- tape between the embossed cavity or to the edge of the cavity whichever is less
- The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other
- B₁ dimension is a reference dimension tape feeder clearance only

cavity

Typical

center line

component

center line

CARRIER TA	APE DIMENS	SIONS in inche	es [millimeters]	FOR 298D,	298W, TR8,	TP8, TL8	
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	W
M ⁽²⁾	8 mm	0.075 [1.91]	0.02 [0.5]	0.138 [3.5]	0.043 [1.10]	0.157 [4.0]	0.315 [8.0]
W	8 mm	0.112 [2.85]	0.039 [1.0]	0.138 [3.5]	0.053 [1.35]	0.157 [4.0]	0.315 [8.0]
R	8 mm	0.098 [2.46]	0.039 [1.0]	0.138 [3.5]	0.066 [1.71]	0.157 [4.0]	0.315 [8.0]
Р	8 mm	0.108 [2.75]	0.02 [0.5]	0.138 [3.5]	0.054 [1.37]	0.157 [4.0]	0.315 [8.0]
Α	8 mm	0.153 [3.90]	0.039 [1.0]	0.138 [3.5]	0.078 [2.00]	0.157 [4.0]	0.315 [8.0]
A0, Q	8 mm	-	0.02 [0.5]	0.138 [3.5]	0.049 [1.25]	0.157 [4.0]	0.315 [8.0]
В	8 mm	0.157 [4.0]	0.039 [1.0]	0.138 [3.5]	0.087[2.22]	0.157 [4.0]	0.315 [8.0]
W9, S	8 mm	0.126 [3.20]	0.029 [0.75]	0.138 [3.5]	0.045 [1.15]	0.157 [4.0]	0.315 [8.0]
B0	12 mm	0.181 [4.61]	0.059 [1.5]	0.217 [5.5]	0.049 [1.25]	0.157 [4.0]	0.472 [12.0]

Notes

- For reference only
- (2) Packaging of M case in plastic tape is available per request



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CARRIER TA	CARRIER TAPE DIMENSIONS in inches [millimeters] FOR TM8									
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	W			
М	8 mm	0.075 [1.91]	0.02 [0.5]	0.138 [3.5]	0.043 [1.10]	0.157 [4.0]	0.315 [8.0]			
G	8 mm	0.077 [1.96]	0.02 [0.5]	0.138 [3.5]	0.051 [1.30]	0.157 [4.0]	0.315 [8.0]			
W	8 mm	0.112 [2.85]	0.039 [1.0]	0.138 [3.5]	0.053 [1.35]	0.157 [4.0]	0.315 [8.0]			
R	8 mm	0.098 [2.46]	0.039 [1.0]	0.138 [3.5]	0.066 [1.71]	0.157 [4.0]	0.315 [8.0]			
Р	8 mm	0.108 [2.75]	0.02 [0.5]	0.138 [3.5]	0.054 [1.37]	0.157 [4.0]	0.315 [8.0]			
Α	8 mm	0.153 [3.90]	0.039 [1.0]	0.138 [3.5]	0.078 [2.00]	0.157 [4.0]	0.315 [8.0]			
N	12 mm	0.154 [3.90]	0.059 [1.5]	0.216 [5.5]	0.051 [1.30]	0.157 [4.0]	0.472 [12.0]			
Т	12 mm	0.154 [3.90]	0.059 [1.5]	0.216 [5.5]	0.067 [1.70]	0.157 [4.0]	0.472 [12.0]			

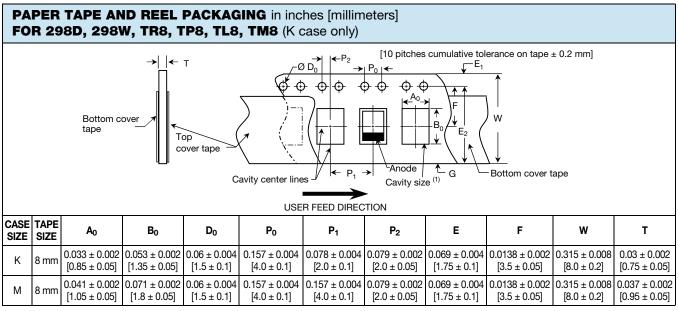
Notes

⁽¹⁾ For reference only

CARRIER TAPE DIMENSIONS in inches [millimeters] FOR T42							
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	W
M2	16 mm	0.404 [10.3]	0.059 [1.5]	0.295 [7.5]	0.176 [4.5]	0.472 [12.0]	0.630 [16.0]

Note

(1) For reference only



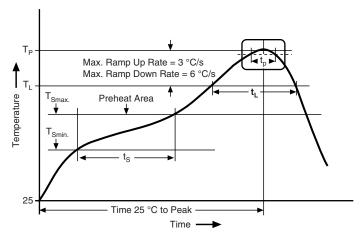
Note

⁽¹⁾ A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°

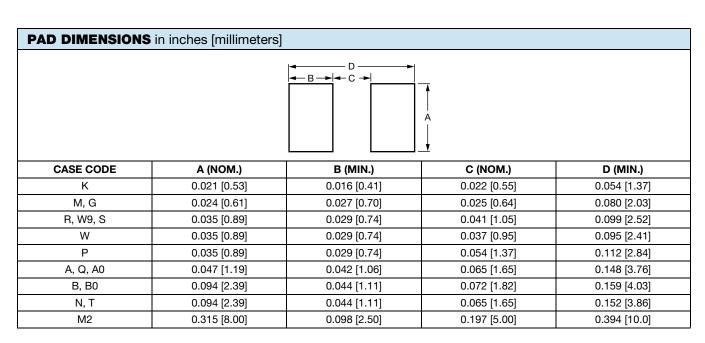


RECOMMENDED REFLOW PROFILES

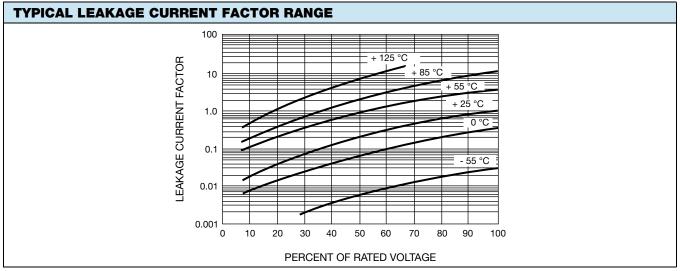
Capacitors should withstand reflow profile as per J-STD-020 standard, three cycles.



PROFILE FEATURE	SnPb EUTECTIC ASSEMBLY	LEAD (Pb)-FREE ASSEMBLY				
PREHEAT AND SOAK						
Temperature min. (T _{Smin.})	100 °C	150 °C				
Temperature max. (T _{Smax.})	150 °C	200 °C				
Time (t _S) from (T _{Smin.} to T _{Smax.})	60 s to 90 s	60 s to 150 s				
RAMP UP						
Ramp-up rate (T _L to T _p)	3 °C/s maximum					
Liquidus temperature (T _L)	183 °C	217 °C				
Time (t _L) maintained above T _L	60 s to 150 s					
Peak package body temperature (T _p) max.	235 °C	260 °C				
Time (t _p) within 5 °C of the peak max. temperature	20 s	30 s				
RAMP DOWN						
Ramp-down rate (T _p to T _L)	6 °C/s maximum					
Time from 25 °C to peak temperature	6 min maximum	8 min maximum				

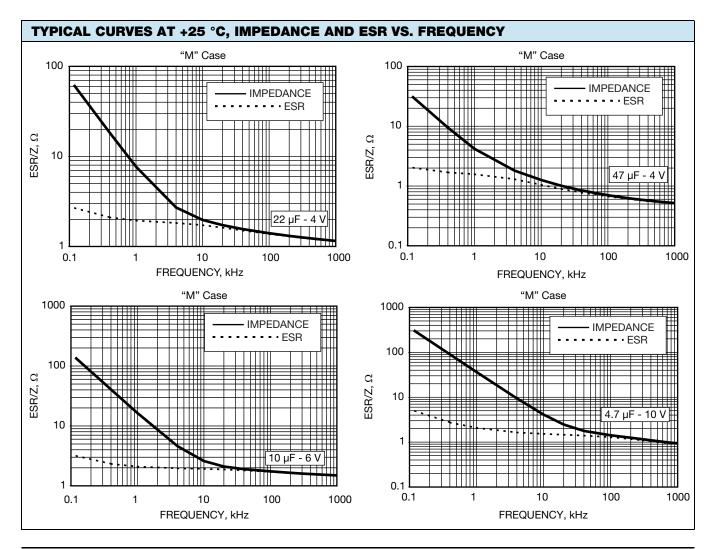






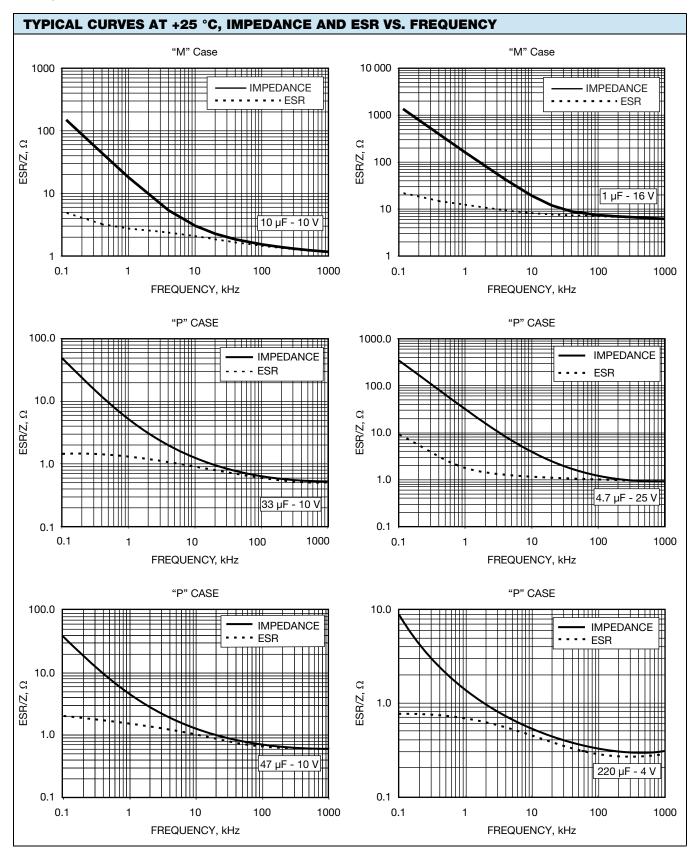
Notes

- At +25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table
- At +85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table
- At +125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table









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GUIDE TO APPLICATION

 AC Ripple Current: the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in watts at +25 °C (see paragraph number 5 and the table Power Dissipation as given in the tables in the product datasheets)

R_{ESR} = the capacitor equivalent series resistance at the specified frequency

2. **AC Ripple Voltage:** the maximum allowable ripple voltage shall be determined from the formula:

$$V_{\text{RMS}} \, = \, Z \sqrt{\frac{P}{R_{\text{ESR}}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

P = power dissipation in watts at +25 °C (see paragraph number 5 and the table Power Dissipation as given in the tables in the product datasheets)

R_{ESR} = the capacitor equivalent series resistance at the specified frequency

Z = the capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at +25 °C.
- 3. **Reverse Voltage:** these capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at +25 °C, 5 % of the DC rating at +25 °C, 5 % of the DC rating at +85 °C, and 1 % of the DC rating at +125 °C.
- 4. **Temperature Derating:** if these capacitors are to be operated at temperatures above +25 °C, the permissible RMS ripple current shall be calculated using the derating factors as shown:

TEMPERATURE	DERATING FACTOR
+25 °C	1.0
+85 °C	0.9
+125 °C	0.4

5. Power Dissipation: power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power Dissipation calculated using +25 °C temperature rise.)

- 6. **Printed Circuit Board Materials:** molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelanized steel).
- 7. Attachment:
- 7.1 **Solder Paste:** the recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.
- 7.2 **Soldering:** capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per s. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor. For details see www.vishay.com/doc?40214.
- 7.2.1 Backward and Forward Compatibility: capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.
- 8. Cleaning (Flux Removal) After Soldering: molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC / ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.
- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. DO NOT EXCEED 9W/I at 40 kHz for 2 min.
- 9. Recommended Mounting Pad Geometries: proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and / or circuit board design.

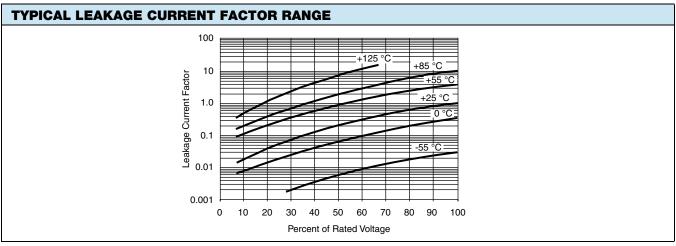


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Solid Tantalum Chip Capacitors MICROTAN® High Reliability Leadframeless Molded Capacitors TM8 and DLA 11020

ELECTRICAL PERFORMANCE CHARACTERISTICS				
ITEM	PERFORMANCE CHARACTERISTICS			
Category temperature range	-55 °C to +85 °C (to +125 °C with voltage derating)			
Capacitance tolerance	± 20 %, ± 10 %, tested via bridge method, at 25 °C, 120 Hz			
Dissipation factor	Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 120 Hz.			
ESR	Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 100 kHz.			
Leakage current	After application of rated voltage applied to capacitors for 5 min using a steady source of power with 1 k Ω resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in Standard Ratings table. Note that the leakage current varies with temperature and applied voltage. See graph below for the appropriate adjustment factor.			
Reverse voltage	Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at +25 °C 5 % of the DC rating at +85 °C 1 % of the DC rating at +125 °C Vishay does not recommend intentional or repetitive application of reverse voltage.			
Ripple current and Temperature derating	For maximum permissible ripple current (I _{RMS}) or/and voltage (V _{RMS}) please refer to product datasheet and Guide to Application. If capacitors are to be used at temperatures above +25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors: 1.0 at +25 °C 0.9 at +85 °C 0.4 at +125 °C			



Notes

- At +25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table.
- At +85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table.
- At +125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table.



Typical Performance Characteristics

Vishay Sprague

ENVIRONMENTAL AND MECHANICAL PERFORMANCE CHARACTERISTICS				
ITEM	CONDITION	POST TEST PERFORMANCE		
Vibration				
Thermal shock				
Resistance to solder heat				
Moisture resistance				
Stability at low and high temperatures	In accordance with MIL-PRF-55365	In accordance with MIL-PRF-55365 (as for style CWR15)		
Surge voltage				
Life test				
Solderability				
Resistance to solvents				
Terminal strength/ Shear stress test	Method: AEC-Q200-006, conditions: Pressure load of 5 N for 10 s ± 1 s	There shall be no mechanical or visual damage and the components shall meet the original electrical requirements.		
Flammability	Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 %.			

Note

• All measurements to be performed after 24 h conditioning at room temperature.



Legal Disclaimer Notice

Vishay

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